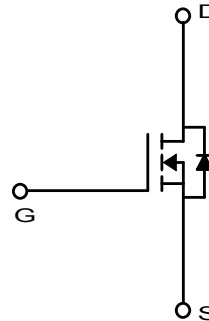
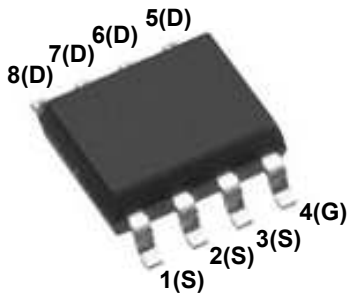


General Description

The MDS1521 uses advanced MagnaChip's MOSFET Technology, which provides high performance in on-state resistance, fast switching performance and excellent quality. MDS1521 is suitable for DC/DC converter and general purpose applications.

Features

- $V_{DS} = 30V$
- $I_D = 28.2A @ V_{GS} = 10V$
- $R_{DS(ON)} < 4.0m\Omega @ V_{GS} = 10V$
 $< 5.5m\Omega @ V_{GS} = 4.5V$
- 100% UIL Tested
- 100% Rg Tested



Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	30	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current ⁽¹⁾	$T_C=25^\circ C$	I_D	28.2	A
	$T_C=70^\circ C$		22.6	
	$T_A=25^\circ C$		18.8 ⁽³⁾	
	$T_A=70^\circ C$		15.1 ⁽³⁾	
Pulsed Drain Current		I_{DM}	40	A
Power Dissipation	$T_C=25^\circ C$	P_D	5.6	W
	$T_C=70^\circ C$		3.6	
	$T_A=25^\circ C$		2.5 ⁽³⁾	
	$T_A=70^\circ C$		1.6 ⁽³⁾	
Single Pulse Avalanche Energy ⁽²⁾		E_{AS}	223	mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{\theta JA}$	50	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	22	

Ordering Information

Part Number	Temp. Range	Package	Packing	Quantity	Rohs Status
MDS1521URH	-55~150°C	SOIC-8	Tape & Reel	3000 units	Halogen Free

Electrical Characteristics (T_J = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.9	2.7	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V T _J =55°C	-	-	1	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V	-	-	±0.1	
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 15A T _J =125°C	-	3.5	4.0	mΩ
		V _{GS} = 4.5V, I _D = 12A	-	4.5	5.5	
Forward Transconductance	g _{fs}	V _{DS} = 5V, I _D = 15A	-	55	-	S
Dynamic Characteristics						
Total Gate Charge	Q _{g(10V)}	V _{DS} = 15.0V, I _D = 15A, V _{GS} = 10V	26.8	38.3	50.0	nC
Total Gate Charge	Q _{g(4.5V)}		12.7	18.2	23.7	
Gate-Source Charge	Q _{gs}		-	7.6	-	
Gate-Drain Charge	Q _{gd}		-	13.3	-	
Input Capacitance	C _{iss}	V _{DS} = 15.0V, V _{GS} = 0V, f = 1.0MHz	1760	2514	3269	pF
Reverse Transfer Capacitance	C _{rss}		163	233	304	
Output Capacitance	C _{oss}		340	486	632	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 15.0V, I _D = 15A, R _G = 3.0Ω	-	9.3	-	ns
Rise Time	t _r		-	24.0	-	
Turn-Off Delay Time	t _{d(off)}		-	39.2	-	
Fall Time	t _f		-	14.0	-	
Gate Resistance	R _g	f=1 MHz	0.5	0.9	3.0	Ω
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 15A, V _{GS} = 0V	-	0.81	1.1	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 15A, di/dt = 100A/μs	-	28.1	42.2	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	19.6	29.3	nC

Note :

1. Surface mounted FR-4 board by JEDEC (jesd51-7)
2. E_{AS} is tested at starting T_J = 25°C, L = 0.1mH, I_{AS} = 37.3A, V_{DD} = 27V, V_{GS} = 10V
3. T < 10sec.

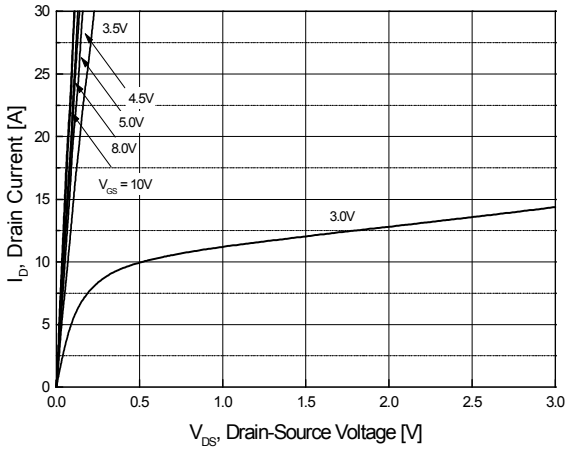


Fig.1 On-Region Characteristics

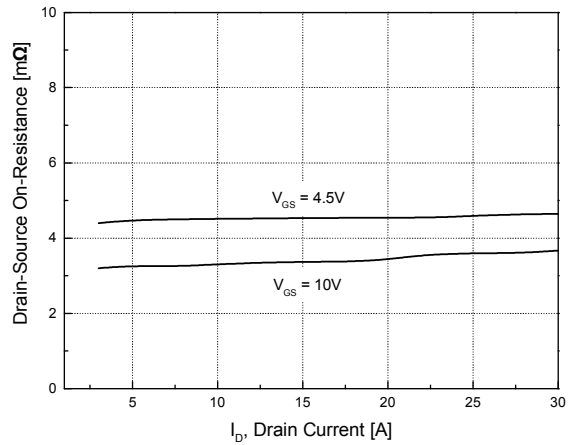


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

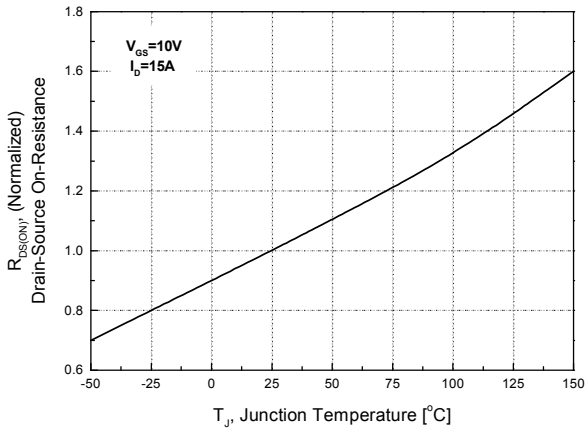


Fig.3 On-Resistance Variation with Temperature

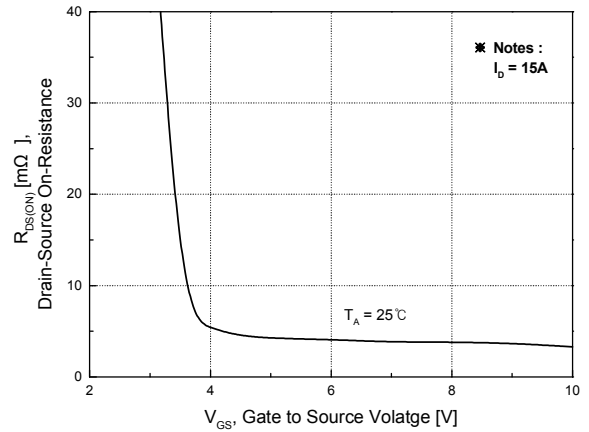


Fig.4 On-Resistance Variation with Gate to Source Voltage

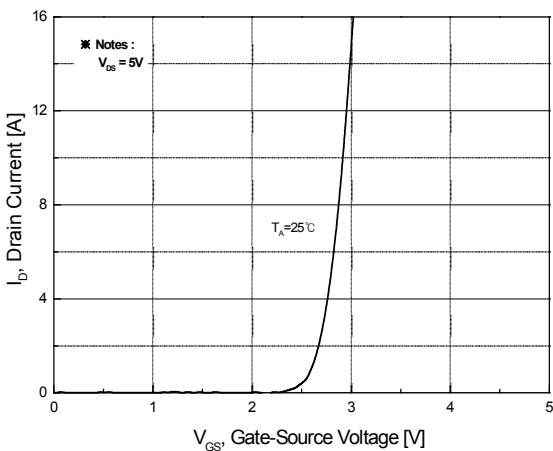


Fig.5 Transfer Characteristics

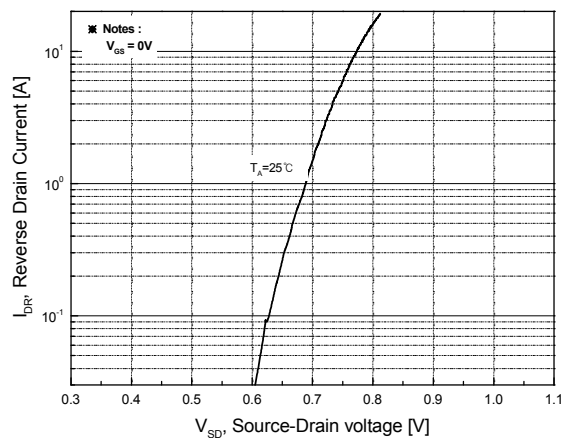


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

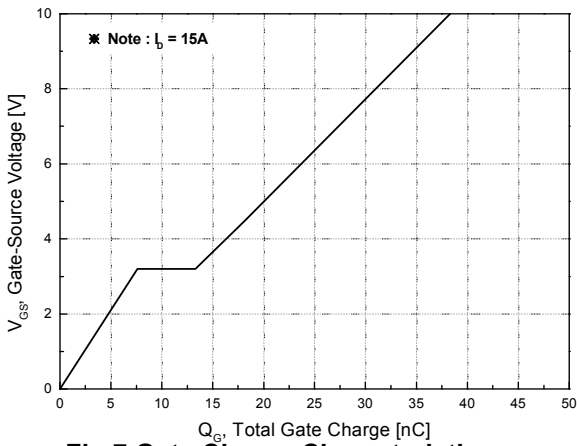


Fig.7 Gate Charge Characteristics

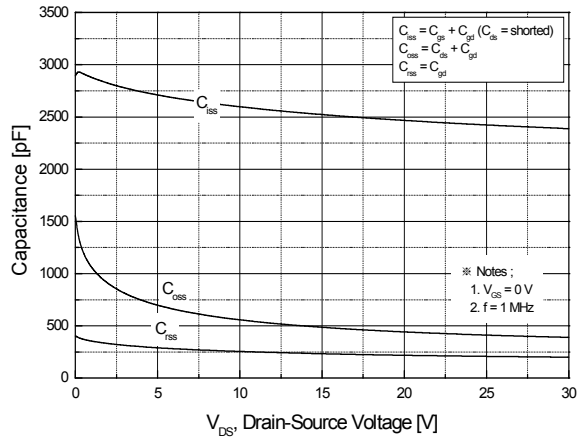


Fig.8 Capacitance Characteristics

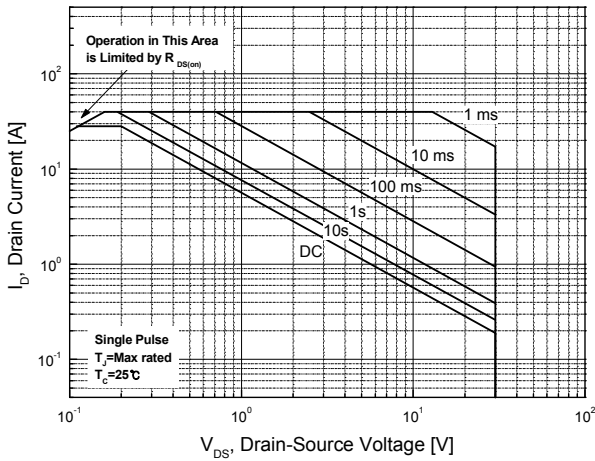


Fig.9 Maximum Safe Operating Area

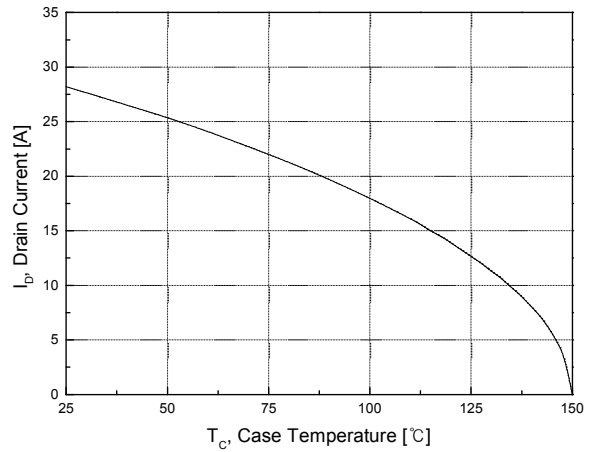


Fig.10 Maximum Drain Current vs. Case Temperature

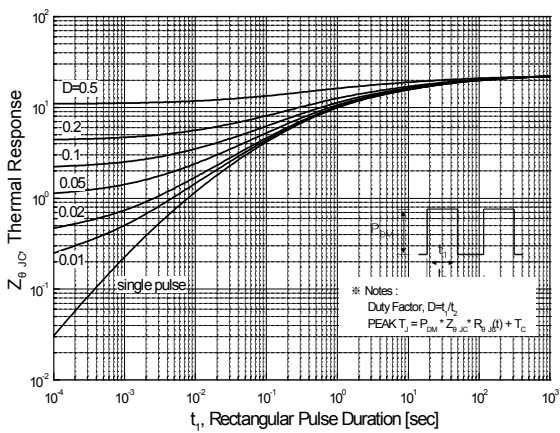
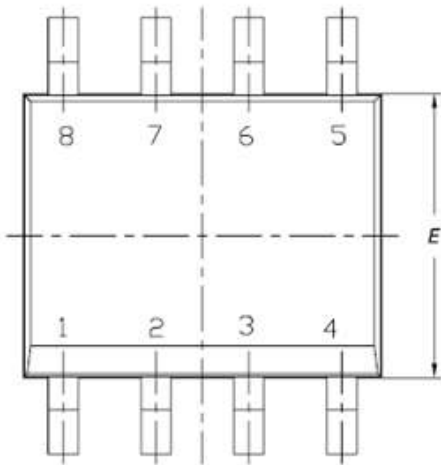


Fig.11 Transient Thermal Response Curve

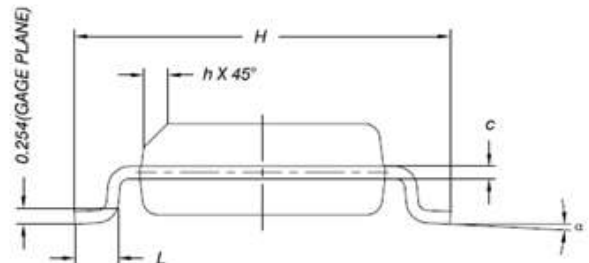
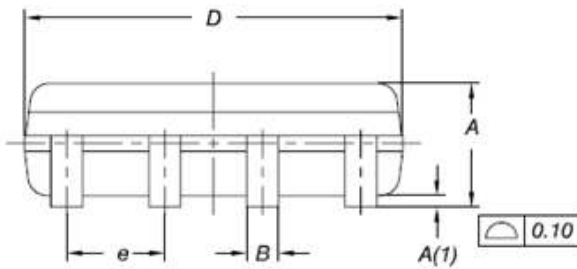
Physical Dimensions

8 Leads, SOIC

Dimensions are in millimeters unless otherwise specified



Symbol	Min	Nom	Max
A	-	-	1.75
A(1)	0.10	-	0.25
B	0.31	-	0.51
C	0.10	-	0.25
D	4.9 BSC		
E	3.9 BSC		
e	1.27 BSC		
H	6.0 BSC		
L	0.40	-	1.27
a	0	-	8
h	0.250	-	0.500
L2(Gage plane)	0.25 BSC		



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